

DAC-02/DAC-03

10-BIT-PLUS-SIGN VOLTAGE-OUTPUT D/A CONVERTERS

Precision Monolithics Inc.

FEATURES

- * Available in Die Form

ORDERING INFORMATION '

MONO-	PACKAGE: 18-PIN CERDIP		
TONOCITY	COMMERC	IAL TEMP	
10	DAC02ACX	DAC03ADX	
8	DAC02CCX	DAC03CDX	
7	DAC02DDX		

Burn-in is available on commercial and industrial temperature range parts in CerDIP, plastic DIP, and TO-can packages. For ordering information, see 1990/91 Data Book, Section 2.

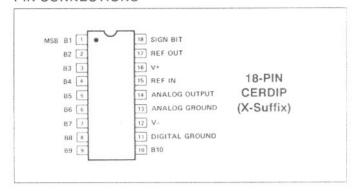
GENERAL DESCRIPTION

The DAC-02 is a complete 10-bit plus sign D/A converter on a single monolithic chip. All elements of a complete sign-magnitude DAC are included; precision voltage reference, current

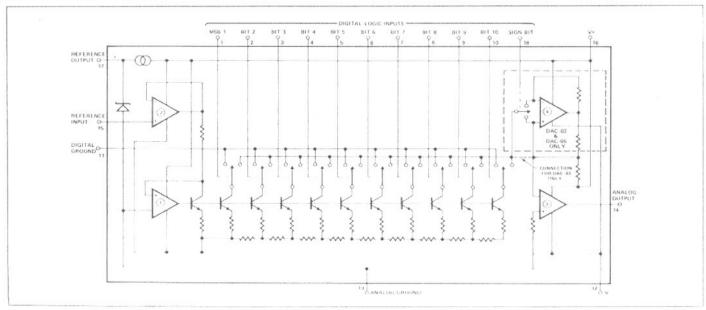
steering logic, current sources, R-2R resistor network, logic-controlled polarity switch, and high speed internally-compensated output op amp. Monotonicity guaranteed over the entire temperature range is achieved using an untrimmed diffused R-2R resistor network. The buffered reference input is capable of tracking over a wide range of voltages, increasing application flexibility. The wide power supply range, low power consumption, wide logic input compatibility and sign-magnitude coding assures utility in a wide range of applications including CRT displays, data acquisition systems, A/D converters, servo positioning controls, and audio digitizing/reconstruction systems.

The DAC-03 is similar in construction to the DAC-02 except for a unipolar only output. This device is intended for low cost, limited temperature range applications, with the same general specifications as its premium counterparts.

PIN CONNECTIONS



SIMPLIFIED SCHEMATIC



7/89, Rev. C



ELECTRICAL CHARACTERISTICS at $V_S = \pm 15V$, $0 \le T_A \le +70^{\circ}C$ for DAC-02, $T_A = +25^{\circ}C$ for DAC-03, unless otherwise noted.

PARAMETER	SYMBOL	CONDITIONS	DAC-02	DAC-03	MIN	TYP	MAX	UNITS
	V.	SB High All other	AC/CC		-	+7	+10	mA
Positive Supply Current	1+	logic inputs low.	DD	ALL.	_	+7	+11.6	
		0011-1-01-0	AC/CC			9	-10	
Negative Supply Current	1-	I— SB High. All other logic inputs low.	DD		***	-9	-11.6	mA
				ALL	464	-10	-11.6	
Power Supply Sensitivity		V _S = ±12 to ±18V	AC/CC		***	±0.015	±0.05	0/1/ 8/
	Pss		DD	ALL	***	±0.015	±0.1	% V _{FS} /V
Power Dissipation	P _d I _{OUT} = 0		AC/CC			225	300	- 14/
		DD	ALL	name.	225	350	mW	
Output Drive Current	10	Guaranteed by V _{FR} test	ALL	ALL	sins.	des	5	mA

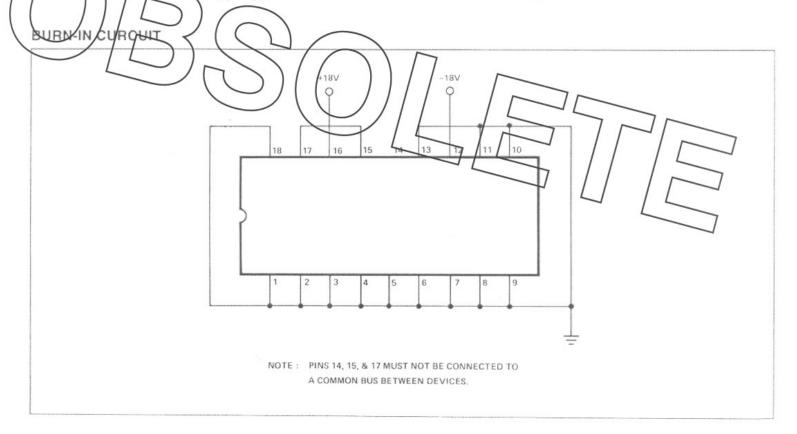
NOTES:

Beference output terminal connected directly to reference input terminal, R, = devices, $R_i = 1k\Omega$ for 5V devices, all logic inputs $\ge 2.0V$.

y is the change in the output voltage produced by switchow (Vzs+ - Vzs)

- 3. Full-scale bipolar symmetry is the magnitude of the difference between $V_{\rm FR+}$ and |V_{FR}_|.

 4. Guaranteed by design.
- 5. Tested with Best Straight Line method.





ARSOLUTE MAXIMUM RATINGS

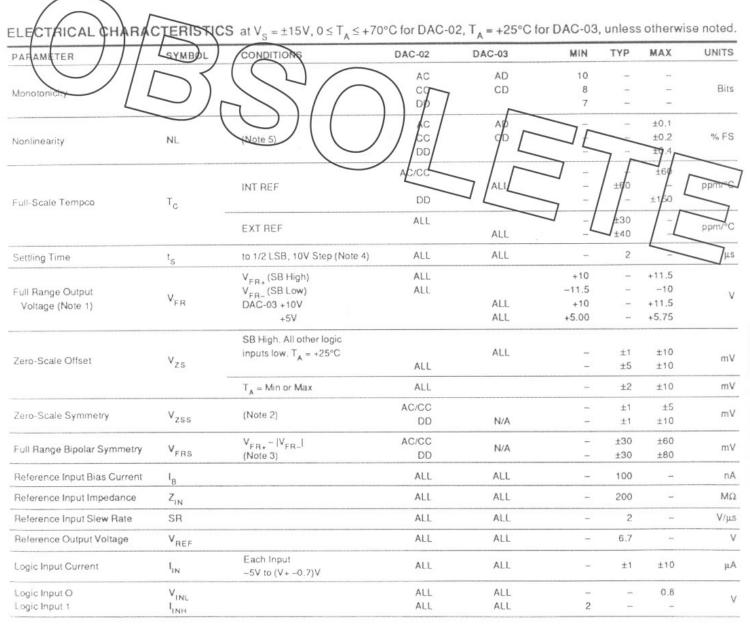
ABSOLUTE MAXIMOM HATHIGO	
Operating Temperature Range	0°C to +70°C
Storage Temperature Range	65°C to +150°C
V+ Supply to Analog Ground	0 to +18V
V- Supply to Analog Ground	0 to -18V
Analog Ground to Digital Ground	0 to ±0.5V
Logic Inputs to Digital Ground	5V to (V+ -0.7V)
Internal Reference Output Current	
Reference Input Voltage	
Lead Temperature (Soldering, 60 sec)	300°C
Output Short-Circuit Duration(Short circuit may be to ground or either s	Indefinite
1	

PACKAGE TYPE	⊖ _{jA} (Note 1)	θ _{JC}	UNITS
18-Pin Hermetic DIP (X)	79	1.1	°C/W

NOTE:

OUTPUT VOLTAGE RANGE SELECTION TABLE

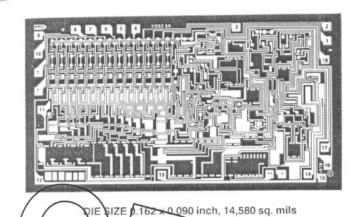
PRODUCT	OUTPUT VOLTAGE RANGE	ADD AS SUFFIX TO PART NO.
DAC02	±10V	1
DAC03	0 to +10V	1
DAC03	0 to +5V	2



Θ_{jA} is specified for worst case mounting conditions, i.e., Θ_{jA} is specified for device in socket for CerDIP package.



DICE CHARACTERISTICS



x/2 286 mm, 9,405 sq. mm)

1. BIT 1-MSB 10. BIT 10

BIT 2
 DIGITAL GROUND

3. BIT 3 12. V-

4. BIT 4 13. ANALOG GROUND
5. BIT 5 14. ANALOG OUTPUT

5. BIT 5 14. ANALO 6. BIT 6 15. REF IN

7. BIT 7 16. V+

8. BIT 8 17. REFOUT

9. BIT 9 18. SIGN BIT

For additional DICE ordering information, refer to 1990/91 Data Book, Section 2.

NOTE:

Voltage output range programmable by connecting *(10V) to analog output for 10 volt range. Jumps from **(5V) to analog output for 5 volt range. †Bits 11 & 12 (not normally used)

WAFER TEST LIMITS at V = ±15V Ta = +85°C and +10V full-scale putput, unless otherwise noted.

PARAMETER	CONDITIONS	DAC-02-N LIMIT	DAC-02-G	UNITS
Resolution (Bits 11 and 12 Not Normally Used)	Bipolar Output Unipolar Output	13/2	13 12	BIGMAX
Monotonicity		9	8	Bits MIN
Nonlinearity		±0.1	±0.2 ~	J L‰ FS MAX
Zero-Scale Offset	Sign Bit High, All Other Inputs Low	±10	±10	mv max
Zero-Scale Symmetry	±10V Full-Scale	±5	±5	mV MAX
Full-Scale Bipolar Symmetry	±10V Full-Scale	±60	±60	mV MAX
Power Supply Rejection	V _S = ±12V to ±18V	0.05	0.05	%V _{FS} /V MAX
Power Dissipation	I _{OUT} = 0	 300	300	mW MAX
Logic Input "0"		 . 0.8	0.8	V MAX
Logic Input "1"		2	2	VMIN
Full Range	Sign-Bit	 ±11.5	±11.5	V MAX
Output Voltage	High or Low	±10	±10	V MIN

NOTE:

Electrical tests are performed at water probe to the limits shown. Due to variations in assembly methods and normal yield loss, yield after packaging is not guaranteed for standard product dice. Consult factory to negotiate specifications based on dice lot qualifications through sample lot assembly and testing.

TYPICAL ELECTRICAL CHARACTERISTICS at $V_S = \pm 15V$ and $\pm 10V$ full-scale output, unless otherwise noted.

PARAMETER	SYMBOL	CONDITIONS	DAC-02-N TYPICAL	DAC-02-G TYPICAL	UNITS
Full-Scale Tempco	TVC _{FS}	Internal Reference	60	60	ppm/°C
Setting Time (T _A = +25°C)	t _s	To ±1/2 LSB 10 Volt Step	2	2	μs
Logic Input Current	I _{IN}	T _A = +25°C	1	1	μΑ

NOTE:

When ordering DICE in this series, use DAC-02 numbers and grades above.

DICE PART NUMBERING SYSTEM Device Type and Model Number **Electrical Grade** ORDERING INFORMATION N = TopG = Middle GR = Lowest Temperature-Tested Die Option (125°C) Visual Criteria STD-883, Method 2010, Test Condition A D-883, Method 2010, Test Condition B DAC-08 N T В All PMI dice are available with either plain backing or, for \$ 50% plus a \$500 lot charge, a 1-micron-thick eutectic-bonded gold backing. Many PMI devices are available with min/max wafer probe limits for dicetested at +125°C. See specific data sheet. Data sheets give specific available grades for each PMI device. Device types listed under packaged products. Select model number from product listings.